2.1 Ω On Resistance, ±15 V/+12 V/±5 V *i*CMOS SPDT Switch

ADG1419

FEATURES

2.1 Ω on resistance
0.5 Ω maximum on resistance flatness at 25°C
Up to 390 mA continuous current
Fully specified at +12 V, ±15 V, ±5 V
No V_L supply required
3 V logic-compatible inputs
Rail-to-rail operation
8-lead MSOP and 8-lead 3 mm × 2 mm LFCSP packages

APPLICATIONS

Automatic test equipment
Data acquisition systems
Battery-powered systems
Relay replacements
Sample-and-hold systems
Audio signal routing
Video signal routing
Communication systems

FUNCTIONAL BLOCK DIAGRAM

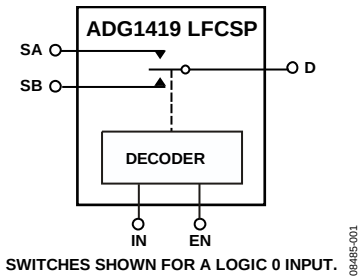

Figure 1. 8-Lead LFCSP Functional Block Diagram

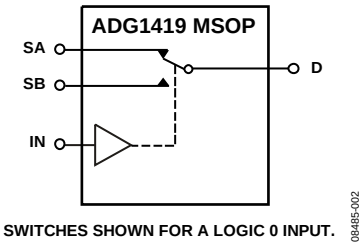

Figure 2. 8-Lead MSOP Functional Block Diagram

GENERAL DESCRIPTION

The ADG1419 is a monolithic *i*CMOS® device containing a single-pole/double-throw (SPDT) switch. An EN input on the LFCSP package is used to enable or disable the device. When disabled, all channels are switched off.

The *i*CMOS (industrial CMOS) modular manufacturing process combines high voltage, complementary metal-oxide semiconductor (CMOS) and bipolar technologies. It enables the development of a wide range of high performance analog ICs capable of 33 V operation in a footprint that no other generation of high voltage parts has achieved. Unlike analog ICs using conventional CMOS processes, *i*CMOS components can tolerate high supply voltages while providing increased performance, dramatically lower power consumption, and reduced package size.

The on resistance profile is very flat over the full analog input range ensuring excellent linearity and low distortion when switching audio signals. The *i*CMOS construction ensures ultralow power dissipation, making the part ideally suited for portable and battery-powered instruments.

Each switch conducts equally well in both directions when on and has an input signal range that extends to the supplies. In the off condition, signal levels up to the supplies are blocked. The ADG1419 exhibits break-before-make switching action for use in multiplexer applications.

PRODUCT HIGHLIGHTS

1. 2.4 Ω maximum on resistance at 25°C.
2. Minimum distortion.
3. 3 V logic-compatible digital inputs: V_{INH} = 2.0 V, V_{INL} = 0.8 V.
4. No V_L logic power supply required.
5. 8-lead MSOP and 8-lead, 3 mm × 2 mm LFCSP packages.

Rev. 0
Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A.
Tel: 781.329.4700 **www.analog.com**
Fax: 781.461.3113
©2009 Analog Devices, Inc. All rights reserved.

TABLE OF CONTENTS

Features 1
Applications 1
Functional Block Diagram 1
General Description 1
Product Highlights 1
Revision History 2
Specifications 3
±15 V Dual Supply 3
+12 V Single Supply 4
±5 V Dual Supply 5
Continuous Current Per Channel, S or D 6
Absolute Maximum Ratings 7
Thermal Resistance 7
ESD Caution 7
Pin Configuration and Function Descriptions 8
Typical Performance Characteristics 9
Test Circuits 12
Terminology 14
Outline Dimensions 15
Ordering Guide 15

REVISION HISTORY

10/09—Revision 0: Initial Version

SPECIFICATIONS

±15 V DUAL SUPPLY

V_{DD} = +15 V ± 10%, V_{SS} = −15 V ± 10%, GND = 0 V, unless otherwise noted.

Table 1.

Parameter	25°C	−40°C to +85°C	−40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			V_{DD} to V_{SS}	V	
On Resistance, R_{ON}	2.1			Ω typ	V_S = ±10 V, I_S = −10 mA; see Figure 22
	2.4	2.8	3.2	Ω max	V_{DD} = +13.5 V, V_{SS} = −13.5 V
On Resistance Match Between Channels, ΔR_{ON}	0.05			Ω typ	V_S = ±10 V, I_S = −10 mA
	0.2	0.25	0.3	Ω max	
On Resistance Flatness, $R_{FLAT\ (ON)}$	0.4			Ω typ	V_S = ±10 V, I_S = −10 mA
	0.5	0.6	0.65	Ω max	
LEAKAGE CURRENTS					V_{DD} = +16.5 V, V_{SS} = −16.5 V
Source Off Leakage, I_S (Off)	±0.1			nA typ	V_S = ±10 V, V_S = ±10 V; see Figure 23
	±0.5	±2	±75	nA max	
Drain Off Leakage, I_D (Off)	±0.2			nA typ	V_S = ±10 V, V_S = ±10 V; see Figure 23
	±0.6	±3	±100	nA max	
Channel On Leakage, I_D, I_S (On)	±0.2			nA typ	V_S = V_D = ±10 V; see Figure 24
	±1	±3	±100	nA max	
DIGITAL INPUTS					
Input High Voltage, V_{INH}			2.0	V min	
Input Low Voltage, V_{INL}			0.8	V max	
Input Current, I_{INL} or I_{INH}	0.005			µA typ	V_{IN} = V_{GND} or V_{DD}
			±0.1	µA max	
Digital Input Capacitance, C_{IN}	4			pF typ	
DYNAMIC CHARACTERISTICS[1]					
Transition Time, $t_{TRANSITION}$	130			ns typ	R_L = 300 Ω, C_L = 35 pF
	155	190	220	ns max	V_S = +10 V; see Figure 25
t_{ON} (EN)	85			ns typ	R_L = 300 Ω, C_L = 35 pF
	110	125	140	ns max	V_S = 10 V; see Figure 27
t_{OFF} (EN)	115			ns typ	R_L = 300 Ω, C_L = 35 pF
	140	160	180	ns max	V_S = 10 V; see Figure 27
Break-Before-Make Time Delay, t_D	15			ns typ	R_L = 300 Ω, C_L = 35 pF
			8	ns min	V_{S1} = V_{S2} = 10 V; see Figure 26
Charge Injection	−16			pC typ	V_S = 0 V, R_S = 0 Ω, C_L = 1 nF; see Figure 28
Off Isolation	−64			dB typ	R_L = 50 Ω, C_L = 5 pF, f = 1 MHz; see Figure 29
Channel-to-Channel Crosstalk	−64			dB typ	R_L = 50 Ω, C_L = 5 pF, f = 1 MHz; see Figure 30
Total Harmonic Distortion + Noise	0.016			% typ	R_L = 10 kΩ, 5 V rms, f = 20 Hz to 20 kHz; see Figure 32
−3 dB Bandwidth	135			MHz typ	R_L = 50 Ω, C_L = 5 pF; see Figure 31
Insertion Loss	0.16			dB typ	R_L = 50 Ω, C_L = 5 pF, f = 1 MHz; see Figure 31
C_S (Off)	19			pF typ	f = 1 MHz; V_S = 0 V
C_D (Off)	44			pF typ	f = 1 MHz; V_S = 0 V
C_D, C_S (On)	114			pF typ	f = 1 MHz; V_S = 0 V

Parameter	25°C	−40°C to +85°C	−40°C to +125°C	Unit	Test Conditions/Comments
POWER REQUIREMENTS					V_{DD} = +16.5 V, V_{SS} = −16.5 V
I_{DD}	0.002			µA typ	Digital inputs = 0 V or V_{DD}
			1.0	µA max	
I_{DD}, 8-Lead MSOP	58			µA typ	Digital inputs = 5 V
			95	µA max	
I_{DD}, 8-Lead LFCSP	120			µA typ	Digital inputs = 5 V
			190	µA max	
I_{SS}	0.002			µA typ	Digital inputs = 0 V, 5 V or V_{DD}
			1.0	µA max	
V_{DD}/V_{SS}			±4.5/±16.5	V min/max	Ground = 0 V

[1] Guaranteed by design, not subject to production test.

+12 V SINGLE SUPPLY

V_{DD} = 12 V ± 10%, V_{SS} = 0 V, GND = 0 V, unless otherwise noted.

Table 2.

Parameter	25°C	−40°C to +85°C	−40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			0 V to V_{DD}	V	
On Resistance, R_{ON}	4			Ω typ	V_S = 0 V to 10 V, I_S = −10 mA; see Figure 22
	4.6	5.5	6.2	Ω max	V_{DD} = +10.8 V, V_{SS} = 0 V
On Resistance Match Between Channels, ΔR_{ON}	0.08			Ω typ	V_S = 0 V to 10 V, I_S = −10 mA
	0.25	0.3	0.35	Ω max	
On Resistance Flatness, $R_{FLAT\ (ON)}$	1.2			Ω typ	V_S = 0 V to 10 V, I_S = −10 mA
	1.5	1.75	1.9	Ω max	
LEAKAGE CURRENTS					V_{DD} = +13.2 V, V_{SS} = 0 V
Source Off Leakage, I_S (Off)	±0.1			nA typ	V_S = 1 V/10 V, V_D = 10 V/1 V; see Figure 23
	±0.5	±2	±75	nA max	
Drain Off Leakage, I_D (Off)	±0.2			nA typ	V_S = 1 V/10 V, V_D = 10 V/1 V; see Figure 23
	±0.6	±3	±100	nA max	
Channel On Leakage, I_D, I_S (On)	±0.2			nA typ	V_S = V_D = 1 V or 10 V; see Figure 24
	±1	±3	±100	nA max	
DIGITAL INPUTS					
Input High Voltage, V_{INH}			2.0	V min	
Input Low Voltage, V_{INL}			0.8	V max	
Input Current, I_{INL} or I_{INH}	0.005			µA typ	V_{IN} = V_{GND} or V_{DD}
			±0.1	µA max	
Digital Input Capacitance, C_{IN}	4			pF typ	
DYNAMIC CHARACTERISTICS[1]					
Transition Time, $t_{TRANSITION}$	200			ns typ	R_L = 300 Ω, C_L = 35 pF
	255	265	370	ns max	V_S = 8 V; see Figure 25
t_{ON} (EN)	145			ns typ	R_L = 300 Ω, C_L = 35 pF
	190	220	245	ns max	V_S = 8 V; see Figure 27
t_{OFF} (EN)	130			ns typ	R_L = 300 Ω, C_L = 35 pF
	170	205	220	ns max	V_S = 8 V; see Figure 27
Break-Before-Make Time Delay, t_D	55			ns typ	R_L = 300 Ω, C_L = 35 pF
			33	ns min	V_{S1} = V_{S2} = 8 V; see Figure 26
Charge Injection	13			pC typ	V_S = 6 V, R_S = 0 Ω, C_L = 1 nF; see Figure 28
Off Isolation	−60			dB typ	R_L = 50 Ω, C_L = 5 pF, f = 1 MHz; see Figure 29

Parameter	25°C	−40°C to +85°C	−40°C to +125°C	Unit	Test Conditions/Comments
Channel-to-Channel Crosstalk	−60			dB typ	R_L = 50 Ω, C_L = 5 pF, f = 1 MHz; see Figure 30
−3 dB Bandwidth	95			MHz typ	R_L = 50 Ω, C_L = 5 pF; see Figure 31
Insertion Loss	0.3			dB typ	R_L = 50 Ω, C_L = 5 pF, f = 1 MHz; see Figure 31
C_S (Off)	32			pF typ	f = 1 MHz; V_S = 6 V
C_D (Off)	72			pF typ	f = 1 MHz; V_S = 6 V
C_D, C_S (On)	123			pF typ	f = 1 MHz; V_S = 6 V
POWER REQUIREMENTS					V_{DD} = 13.2 V
I_{DD}	0.001			µA typ	Digital inputs = 0 V or V_{DD}
			1.0	µA max	
I_{DD}, 8-Lead MSOP	58			µA typ	Digital inputs = 5 V
			95	µA max	
I_{DD}, 8-Lead LFCSP	120			µA typ	Digital inputs = 5 V
			190	µA max	
V_{DD}			5/16.5	V min/max	Ground = 0 V, V_{SS} = 0 V

[1] Guaranteed by design, not subject to production test.

±5 V DUAL SUPPLY

V_{DD} = +5 V ± 10%, V_{SS} = −5 V ± 10%, GND = 0 V, unless otherwise noted.

Table 3.

Parameter	25°C	−40°C to +85°C	−40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			V_{DD} to V_{SS}	V	
On Resistance, R_{ON}	4.5			Ω typ	V_S = ±4.5V, I_S = −10 mA; see Figure 22
	5.2	6.2	7	Ω max	V_{DD} = +4.5 V, V_{SS} = −4.5 V
On Resistance Match Between Channels, ΔR_{ON}	0.1			Ω typ	V_S = ±4.5V, I_S = −10 mA
	0.3	0.35	0.4	Ω max	
On Resistance Flatness, $R_{FLAT\ (ON)}$	1.3			Ω typ	V_S = ±4.5 V, I_S = −10 mA
	1.6	1.85	2	Ω max	
LEAKAGE CURRENTS					V_{DD} = +5.5 V, V_{SS} = −5.5 V
Source Off Leakage, I_S (Off)	±0.1			nA typ	V_S = ±4.5 V, V_D = ∓4.5 V; see Figure 23
	±0.5	±2	±75	nA max	
Drain Off Leakage, I_D (Off)	±0.1			nA typ	V_S = ±4.5 V, V_D = ∓4.5 V; see Figure 23
	±0.6	±3	±100	nA max	
Channel On Leakage, I_D, I_S (On)	±0.1			nA typ	V_S = V_D = ±4.5 V; see Figure 24
	±1	±3	±100	nA max	
DIGITAL INPUTS					
Input High Voltage, V_{INH}			2.0	V min	
Input Low Voltage, V_{INL}			0.8	V max	
Input Current, I_{INL} or I_{INH}	0.001			µA typ	V_{IN} = V_{GND} or V_{DD}
			±0.1	µA max	
Digital Input Capacitance, C_{IN}	4			pF typ	

Parameter	25°C	−40°C to +85°C	−40°C to +125°C	Unit	Test Conditions/Comments
DYNAMIC CHARACTERISTICS[1]					
Transition Time, $t_{TRANSITION}$	310			ns typ	R_L = 300 Ω, C_L = 35 pF
	410	495	560	ns max	V_S = 3 V; see Figure 25
t_{ON} (EN)	230			ns typ	R_L = 300 Ω, C_L = 35 pF
	305	355	390	ns max	V_S = 3 V; see Figure 27
t_{OFF} (EN)	220			ns typ	R_L = 300 Ω, C_L = 35 pF
	290	335	365	ns max	V_S = 3 V; see Figure 27
Break-Before-Make Time Delay, t_D	65			ns typ	R_L = 300 Ω, C_L = 35 pF
			31	ns min	V_{S1} = V_{S2} = 3 V; see Figure 26
Charge Injection	59			pC typ	V_S = 0 V, R_S = 0 Ω, C_L = 1 nF; see Figure 28
Off Isolation	−60			dB typ	R_L = 50 Ω, C_L = 5 pF, f = 1 MHz; see Figure 29
Channel-to-Channel Crosstalk	−60			dB typ	R_L = 50 Ω, C_L = 5 pF, f = 1 MHz; see Figure 30
Total Harmonic Distortion + Noise	0.04			% typ	R_L = 10 kΩ, 5 V p-p, f = 20 Hz to 20 kHz; see Figure 32
−3 dB Bandwidth	105			MHz typ	R_L = 50 Ω, C_L = 5 pF; see Figure 31
Insertion Loss	0.28			dB typ	R_L = 50 Ω, C_L = 5 pF, f = 1 MHz; see Figure 31
C_S (Off)	26			pF typ	V_S = 0 V, f = 1 MHz
C_D (Off)	62			pF typ	V_S = 0 V, f = 1 MHz
C_D, C_S (On)	128			pF typ	V_S = 0 V, f = 1 MHz
POWER REQUIREMENTS					V_{DD} = +5.5 V, V_{SS} = −5.5 V
I_{DD}	0.001			µA typ	Digital inputs = 0 V or V_{DD}
			1.0	µA max	
I_{SS}	0.001			µA typ	Digital inputs = 0 V or V_{DD}
			1.0	µA max	
V_{DD}/V_{SS}			±4.5/±16.5	V min/max	Ground = 0 V

[1] Guaranteed by design, not subject to production test.

CONTINUOUS CURRENT PER CHANNEL, S OR D

Table 4.

Parameter	25°C	85°C	125°C	Unit	Test Conditions/Comments
CONTINUOUS CURRENT PER CHANNEL[1]					
±15 V Dual Supply					V_{DD} = +13.5 V, V_{SS} = −13.5 V
8-Lead MSOP (θ_{JA} = 206°C/W)	215	135	80	mA maximum	
8-Lead LFCSP (θ_{JA} = 50.8°C/W)	390	215	100	mA maximum	
+12 V Single Supply					V_{DD} = 10.8 V, V_{SS} = 0 V
8-Lead MSOP (θ_{JA} = 206°C/W)	175	115	70	mA maximum	
8-Lead LFCSP (θ_{JA} = 50.8°C/W)	320	185	95	mA maximum	
±5 V Dual Supply					V_{DD} = +4.5 V, V_{SS} = −4.5 V
8-Lead MSOP (θ_{JA} = 206°C/W)	165	110	70	mA maximum	
8-Lead LFCSP (θ_{JA} = 50.8°C/W)	310	180	95	mA maximum	

[1] Guaranteed by design, not subject to production test.

ABSOLUTE MAXIMUM RATINGS

T_A = 25°C, unless otherwise noted.

Table 5.

Parameter	Rating
V_{DD} to V_{SS}	35 V
V_{DD} to GND	−0.3 V to +25 V
V_{SS} to GND	+0.3 V to −25 V
Analog Inputs[1]	V_{SS} − 0.3 V to V_{DD} + 0.3 V or 30 mA, whichever occurs first
Digital Inputs[1]	GND − 0.3 V to V_{DD} + 0.3 V or 30 mA, whichever occurs first
Peak Current, S or D (Pulsed at 1 ms, 10% Duty-Cycle Maximum)	
8-Lead MSOP (4-Layer Board)	400 mA
8-Lead LFCSP	600 mA
Continuous Current per Channel, S or D	Data in Table 4 + 15% mA
Operating Temperature Range	
Industrial	−40°C to +125°C
Storage Temperature Range	−65°C to +150°C
Junction Temperature	150°C
Reflow Soldering Peak Temperature, Pb Free	260°C

[1] Over voltages at IN, S, or D are clamped by internal diodes. Current should be limited to the maximum ratings given.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

Table 6. Thermal Resistance

Package Type	θ_{JA}	θ_{JC}	Unit
8-Lead MSOP (4-Layer Board)	206	44	°C/W
8-Lead LFCSP	50.8		°C/W

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

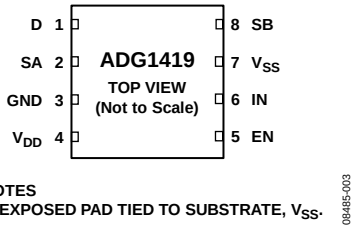

Figure 3. 8-Lead LFCSP Pin Configuration

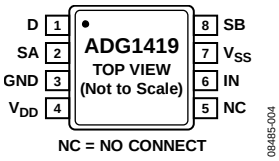

Figure 4. 8-Lead MSOP Pin Configuration

Table 7. 8-Lead LFCSP Pin Function Descriptions

Pin No.	Mnemonic	Description
1	D	Drain Terminal. This pin can be an input or output.
2	SA	Source Terminal. This pin can be an input or output.
3	GND	Ground (0 V) Reference.
4	V_{DD}	Most Positive Power Supply Potential.
5	EN	Active High Digital Input. When this pin is low, the device is disabled and all switches are turned off. When this pin is high, the IN logic input determines which switch is turned on.
6	IN	Logic Control Input.
7	V_{SS}	Most Negative Power Supply Potential.
8	SB	Source Terminal. This pin can be an input or output.
	EPAD	Exposed pad tied to substrate, V_{SS}.

Table 8. 8-Lead LFCSP Truth Table

EN	IN	Switch A	Switch B
0	X	Off	Off
1	0	On	Off
1	1	Off	On

Table 9. 8-Lead MSOP Pin Function Descriptions

Pin No.	Mnemonic	Description
1	D	Drain Terminal. This pin can be an input or output.
2	SA	Source Terminal. This pin can be an input or output.
3	GND	Ground (0 V) Reference.
4	V_{DD}	Most Positive Power Supply Potential.
5	NC	No Connect.
6	IN	Logic Control Input.
7	V_{SS}	Most Negative Power Supply Potential.
8	SB	Source Terminal. This pin can be an input or output.

Table 10. 8-Lead MSOP Truth Table

IN	Switch A	Switch B
0	On	Off
1	Off	On

TYPICAL PERFORMANCE CHARACTERISTICS

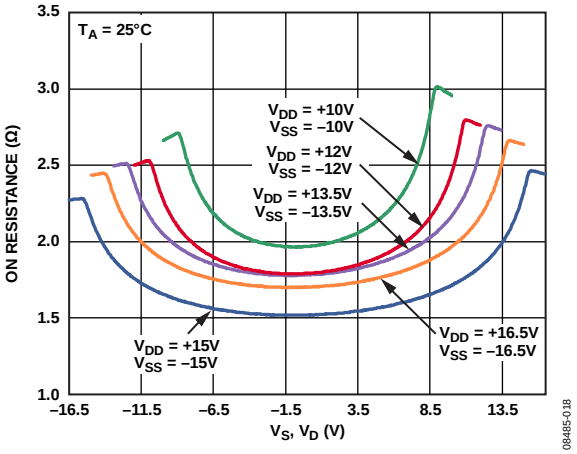

Figure 5. On Resistance as a Function of V_D (V_S) for Dual Supply

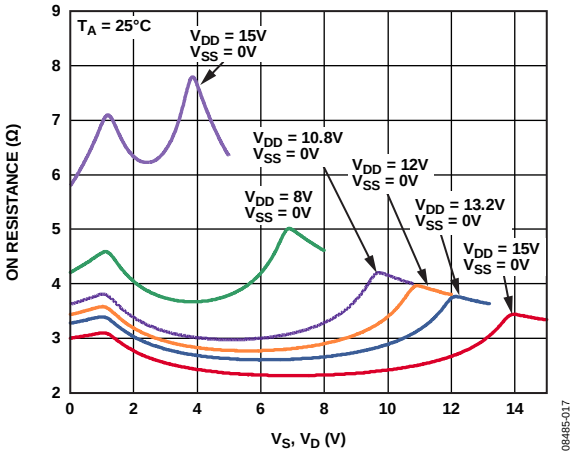

Figure 6. On Resistance as a Function of V_D (V_S) for Single Supply

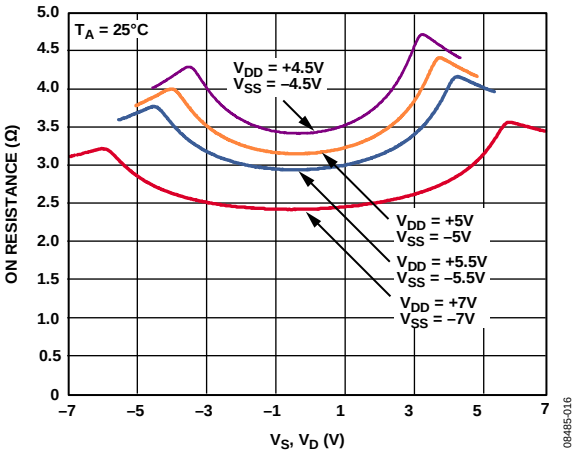

Figure 7. On Resistance as a Function of V_D (V_S) for Dual Supply

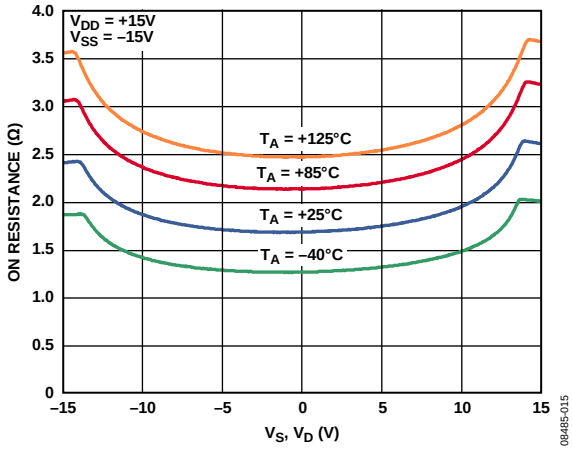

Figure 8. On Resistance as a Function of V_D (V_S) for Different Temperatures, ±15 V Dual Supply

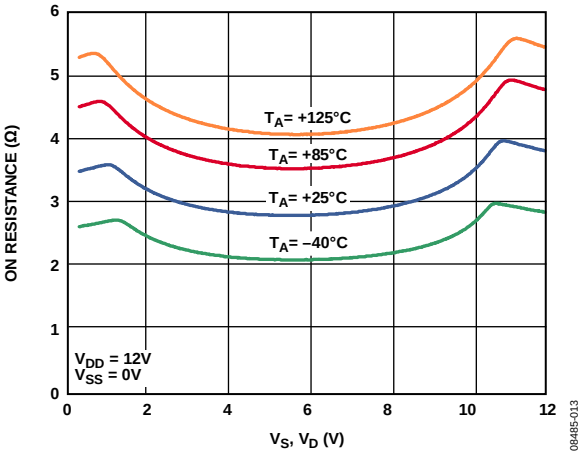

Figure 9. On Resistance as a Function of V_D (V_S) for Different Temperatures, +12 V Single Supply

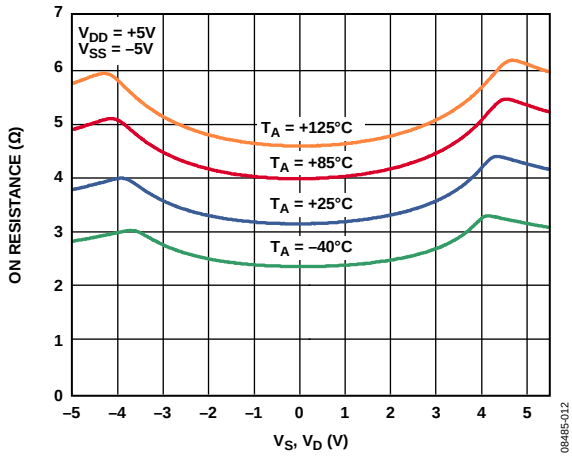

Figure 10. On Resistance as a Function of V_D (V_S) for Different Temperatures, ±5 V Dual Supply

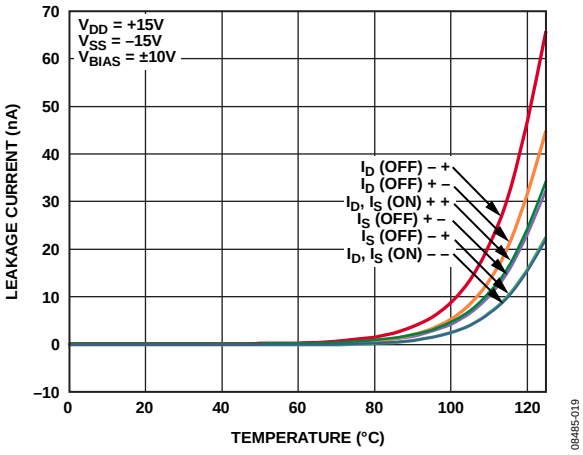

Figure 11. Leakage Currents as a Function of Temperature, ±15 V Dual Supply

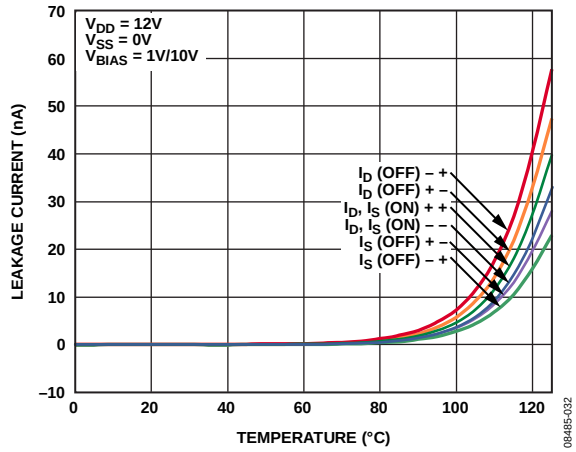

Figure 12. Leakage Currents as a Function of Temperature, +12 V Single Supply

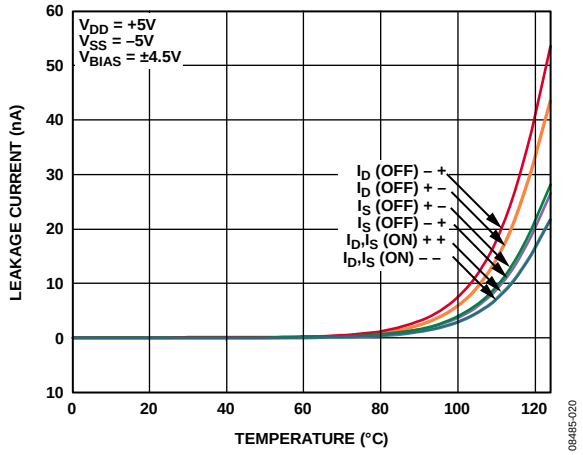

Figure 13. Leakage Currents as a Function of Temperature, ±5 V Dual Supply

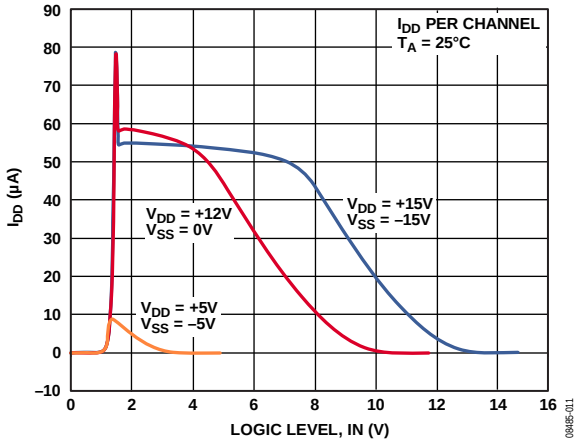

Figure 14. I_{DD} vs. Logic Level

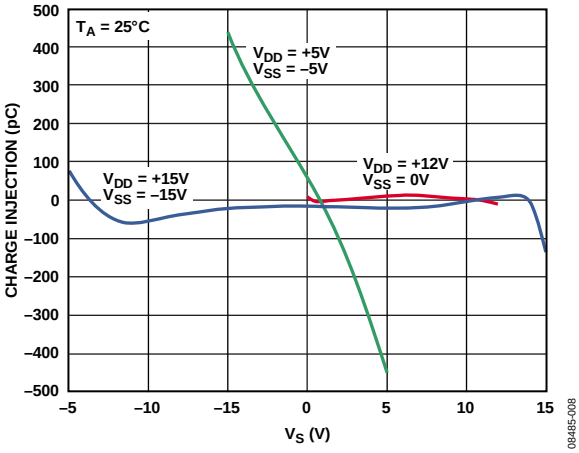

Figure 15. Charge Injection vs. Source Voltage

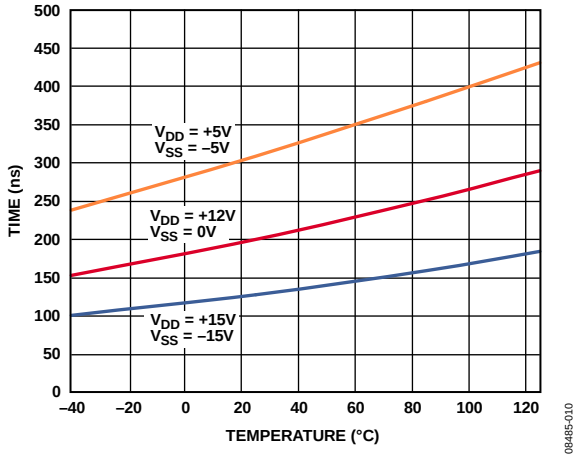

Figure 16. $t_{TRANSITION}$ Times vs. Temperature

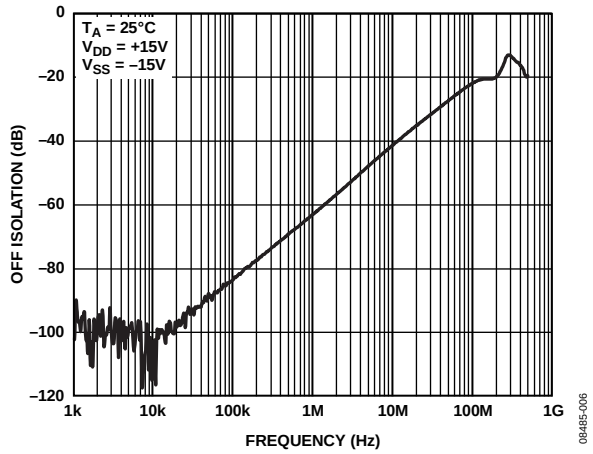

Figure 17. Off Isolation vs. Frequency

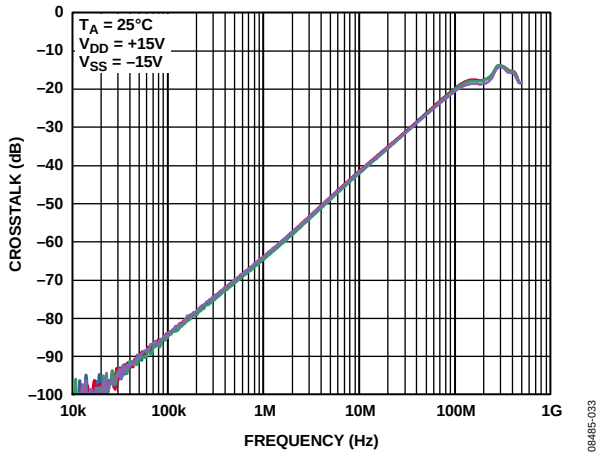

Figure 18. Crosstalk vs. Frequency

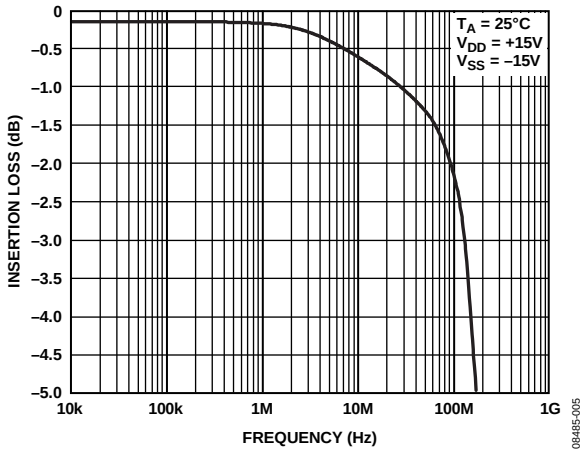

Figure 19. On Response vs. Frequency

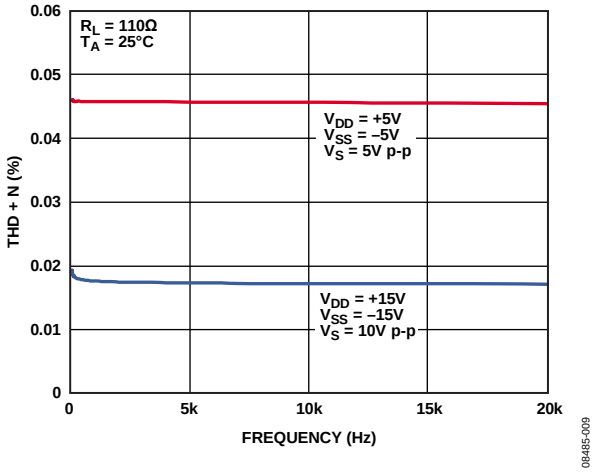

Figure 20. THD + N vs. Frequency

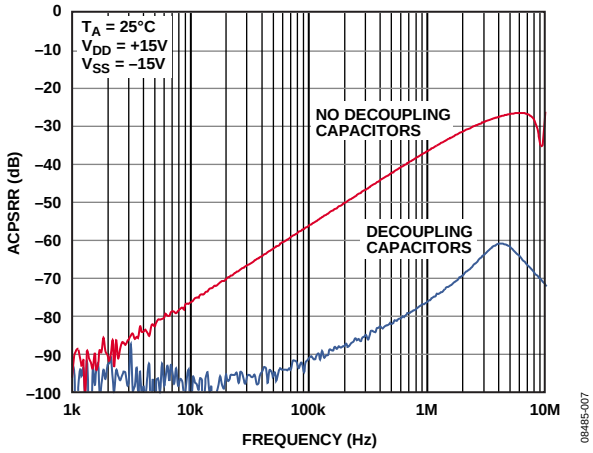

Figure 21. ACPSRR vs. Frequency

TEST CIRCUITS

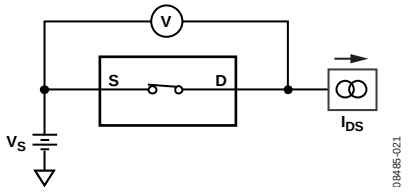

Figure 22. On Resistance

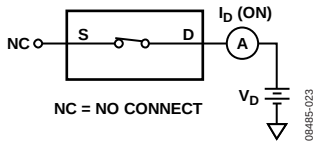

Figure 24. On Leakage

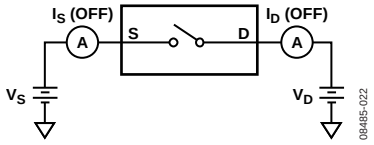

Figure 23. Off Leakage

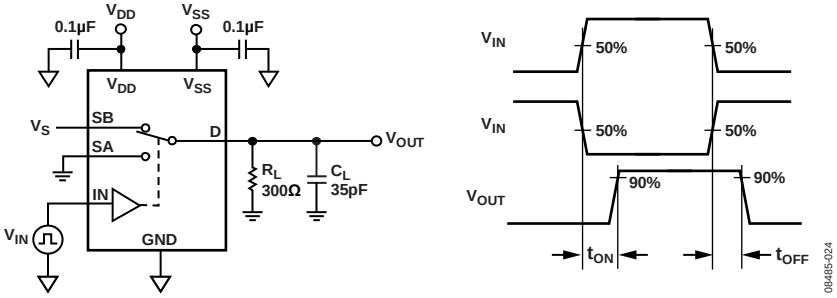

Figure 25. Switching Times, t_{ON} and t_{OFF}

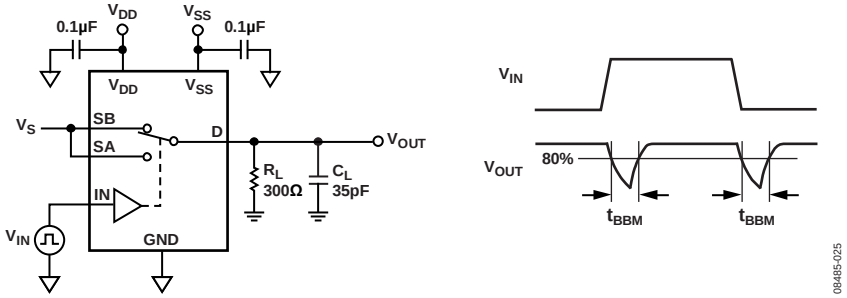

Figure 26. Break-Before-Make Time Delay

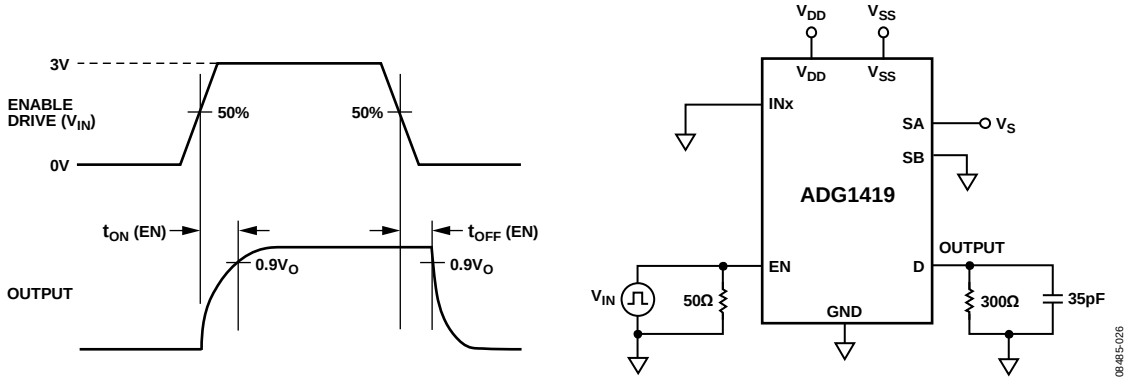

Figure 27. Enable Delay, t_{ON} (EN), t_{OFF} (EN)

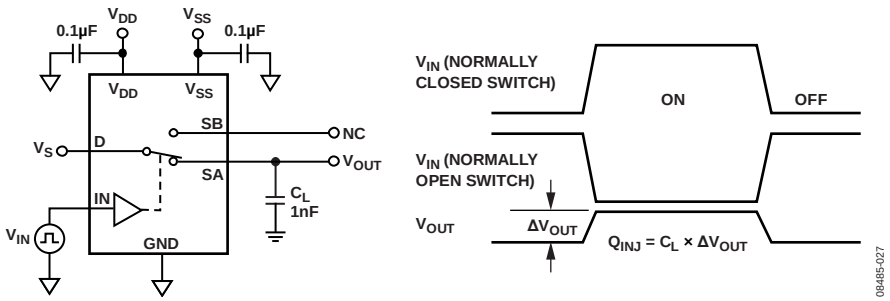

Figure 28. Charge Injection

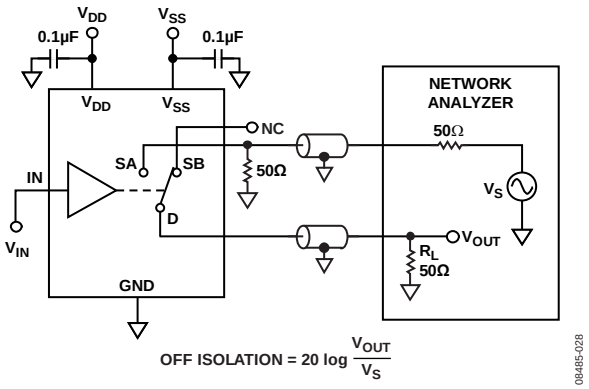

Figure 29. Off Isolation

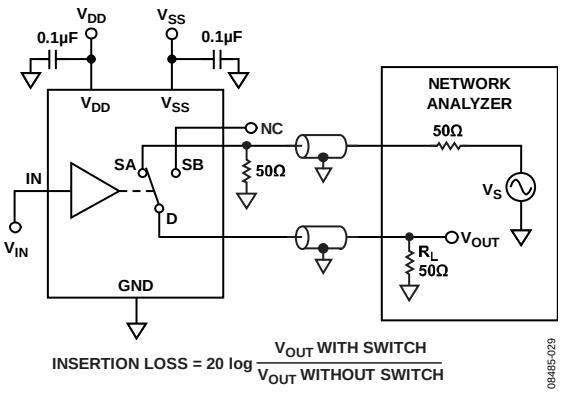

Figure 31. Bandwidth

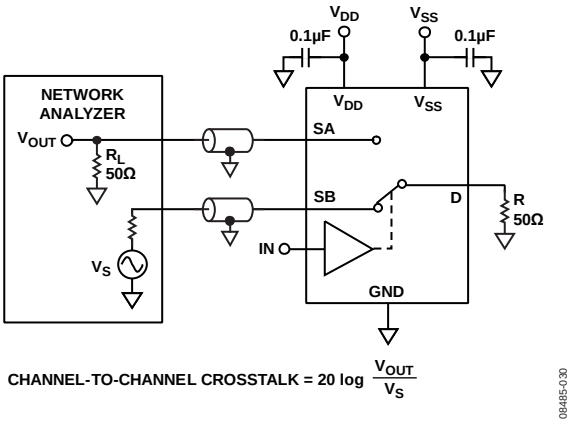

Figure 30. Channel-to-Channel Crosstalk

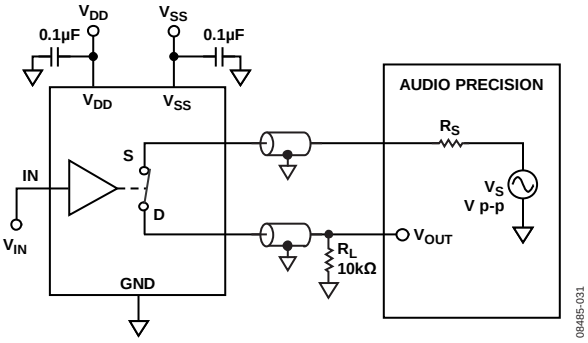

Figure 32. THD + N

TERMINOLOGY

I_{DD}
The positive supply current.

I_{SS}
The negative supply current.

V_D (V_S)
The analog voltage on Terminal D and Terminal S.

R_{ON}
The ohmic resistance between Terminal D and Terminal S.

$R_{FLAT\ (ON)}$
Flatness is defined as the difference between the maximum and minimum value of on resistance as measured over the specified analog signal range.

I_S (Off)
The source leakage current with the switch off.

I_D (Off)
The drain leakage current with the switch off.

I_D, I_S (On)
The channel leakage current with the switch on.

V_{INL}
The maximum input voltage for Logic 0.

V_{INH}
The minimum input voltage for Logic 1.

I_{INL} (I_{INH})
The input current of the digital input.

C_S (Off)
The off switch source capacitance, measured with reference to ground.

C_D (Off)
The off switch drain capacitance, measured with reference to ground.

C_D, C_S (On)

The on switch capacitance, measured with reference to ground.

C_{IN}
The digital input capacitance.

t_{ON} (EN)
Delay time between the 50% and 90% points of the digital input and switch on condition. See Figure 27.

t_{OFF} (EN)
Delay time between the 50% and 90% points of the digital input and switch off condition. See Figure 27.

$t_{TRANSITION}$
Delay time between the 50% and 90% points of the digital inputs and the switch on condition when switching from one address state to another.

T_{BBM}
Off time measured between the 80% point of both switches when switching from one address state to another. See Figure 26.

Charge Injection
A measure of the glitch impulse transferred from the digital input to the analog output during switching. See Figure 28.

Off Isolation
A measure of unwanted signal coupling through an off switch. See Figure 29.

Crosstalk
A measure of unwanted signal that is coupled through from one channel to another as a result of parasitic capacitance. See Figure 30.

Bandwidth
The frequency at which the output is attenuated by 3 dB. See Figure 31.

On Response
The frequency response of the on switch.

Insertion Loss
The loss due to the on resistance of the switch. See Figure 31.

THD + N
The ratio of the harmonic amplitude plus noise of the signal to the fundamental. See Figure 32.

AC Power Supply Rejection Ratio (ACPSRR)
ACPSRR measures the ability of a part to avoid coupling noise and spurious signals that appear on the supply voltage pin to the output of the switch. The dc voltage on the device is modulated by a sine wave of 0.62 V p-p. The ratio of the amplitude of signal on the output to the amplitude of the modulation is the ACPSRR. See Figure 21.

OUTLINE DIMENSIONS

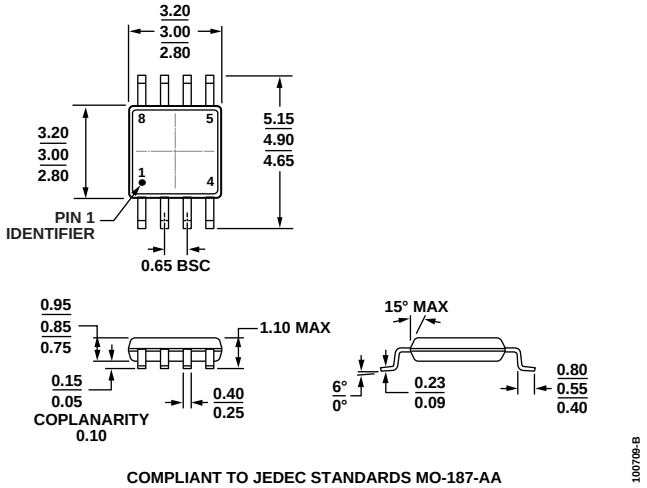

Figure 33. 8-Lead Mini Small Outline Package [MSOP]
(RM-8)
Dimensions shown in millimeters

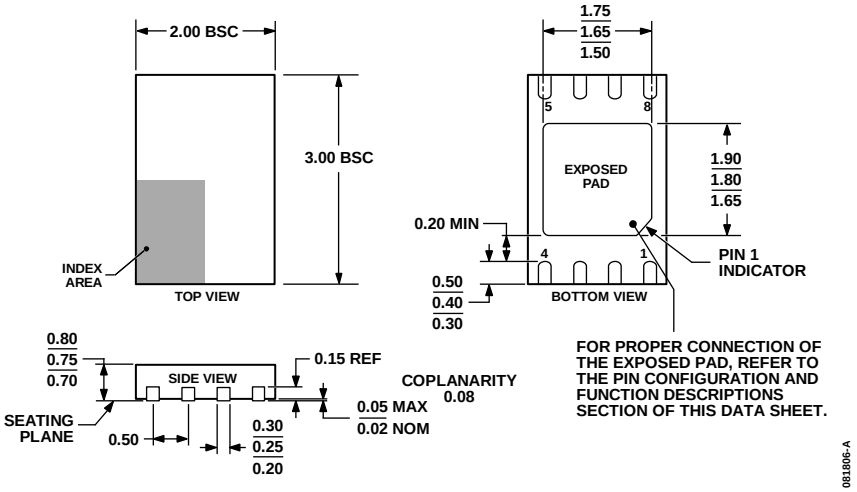

Figure 34. 8-Lead Lead Frame Chip Scale Package [LFCSP_WD]
3 mm × 2 mm Body, Very Very Thin, Dual Lead
(CP-8-4)
Dimensions shown in millimeters

ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option	Branding
ADG1419BRMZ[1]	−40°C to +125°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	S1L
ADG1419BRMZ-REEL7[1]	−40°C to +125°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	S1L
ADG1419BCPZ-REEL7[1]	−40°C to +125°C	8-Lead Lead Frame Chip Scale Package [LFCSP_WD]	CP-8-4	1C

[1] Z = RoHS Compliant Part.

NOTES

©2009 Analog Devices, Inc. All rights reserved. Trademarks and registered trademarks are the property of their respective owners.
D08485-0-10/09(0)

AMEYA360
Components Supply Platform

Authorized Distribution Brand :

Website :

Welcome to visit www.ameya360.com

Contact Us :

- ## Address :

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd
Minhang District, Shanghai , China

- ## Sales :

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

- ## Customer Service :

Email service@ameya360.com

- ## Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com